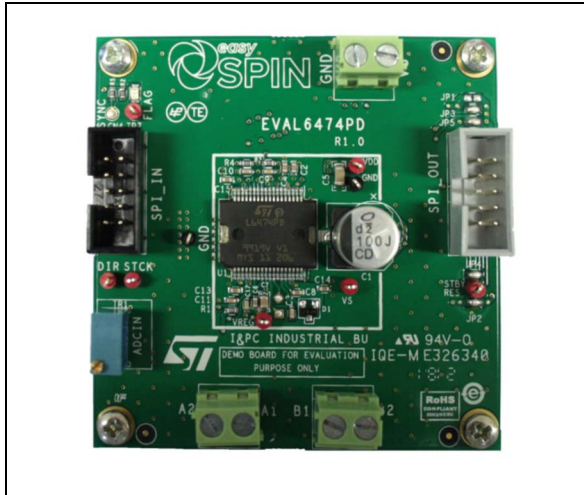


Stepper motor driver mounting the L6474 in a high power PowerSO package

Data brief



Description

The EVAL6474PD demonstration board is a microstepping motor driver. In combination with the STEVAL-PCC009V2 communication board and SPIN evaluation software, the board allows the user to investigate all the features of the L6474 device.

The 4-layer layout and the PowerSO package allow the highest thermal performance to be obtained.

The EVAL6474PD supports the daisy chain configuration making it suitable for the evaluation of the L6474 in multi motor applications.

Features

- Voltage range from 8 V to 45 V
- Phase current up to 3 A_{r.m.s.}
- SPI with daisy chain feature
- Socket for external resonator or crystal
- FLAG LED indicator
- Suitable for use in combination with STEVAL-PCC009V2

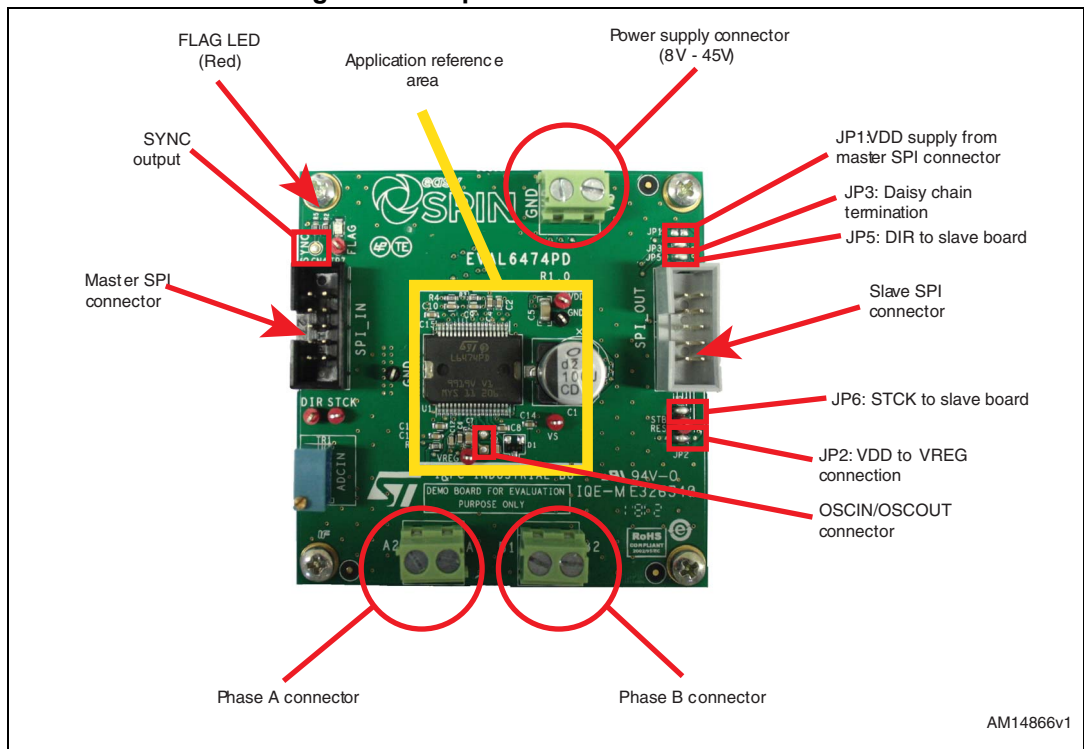
Board description

Table 1. EVAL6474PD specifications

Parameter	Value
Supply voltage (VS)	8 to 45 V
Maximum output current (each phase)	3 A _{r.m.s.}
Logic supply voltage (VREG)	Externally supplied: 3.3 V Internally supplied: 3 V typical
Logic interface voltage (VDD)	Externally supplied: 3.3 V or 5 V Internally supplied: VREG
Low level logic input voltage	0 V
High level logic input voltage	VDD ⁽¹⁾
Operating temperature	-25 to +125 °C
L6474PD thermal resistance junction to ambient	12 °C/W typical

1. All logic inputs are 5 V tolerant.

Figure 1. Jumper and connector location



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Table 2. Jumper and connector description

Name	Type	Function
M1	Power supply	Motor supply voltage
M2	Power output	Bridge A outputs
M3	Power output	Bridge B outputs
CN1	SPI connector	Master SPI
CN2	SPI connector	Slave SPI
CN3	NM connector	OSCIN and OSCOUT pins
CN4	NM connector	SYNC output
TP1 (VS)	Test point	Motor supply voltage test point
TP2 (VDD)	Test point	Logic interface supply voltage test point
TP6 (VREG)	Test point	Logic supply voltage/L6474 internal regulator test point
TP4 TP5 (GND)	Test point	Ground test point
TP8 (STCK)	Test point	Step-clock input test point
TP3 (DIR)	Test point	BUSY/SYNC output test point
TP9 (STBY/RES)	Test point	Standby/reset input test point
TP7(FLAG)	Test point	FLAG output test point

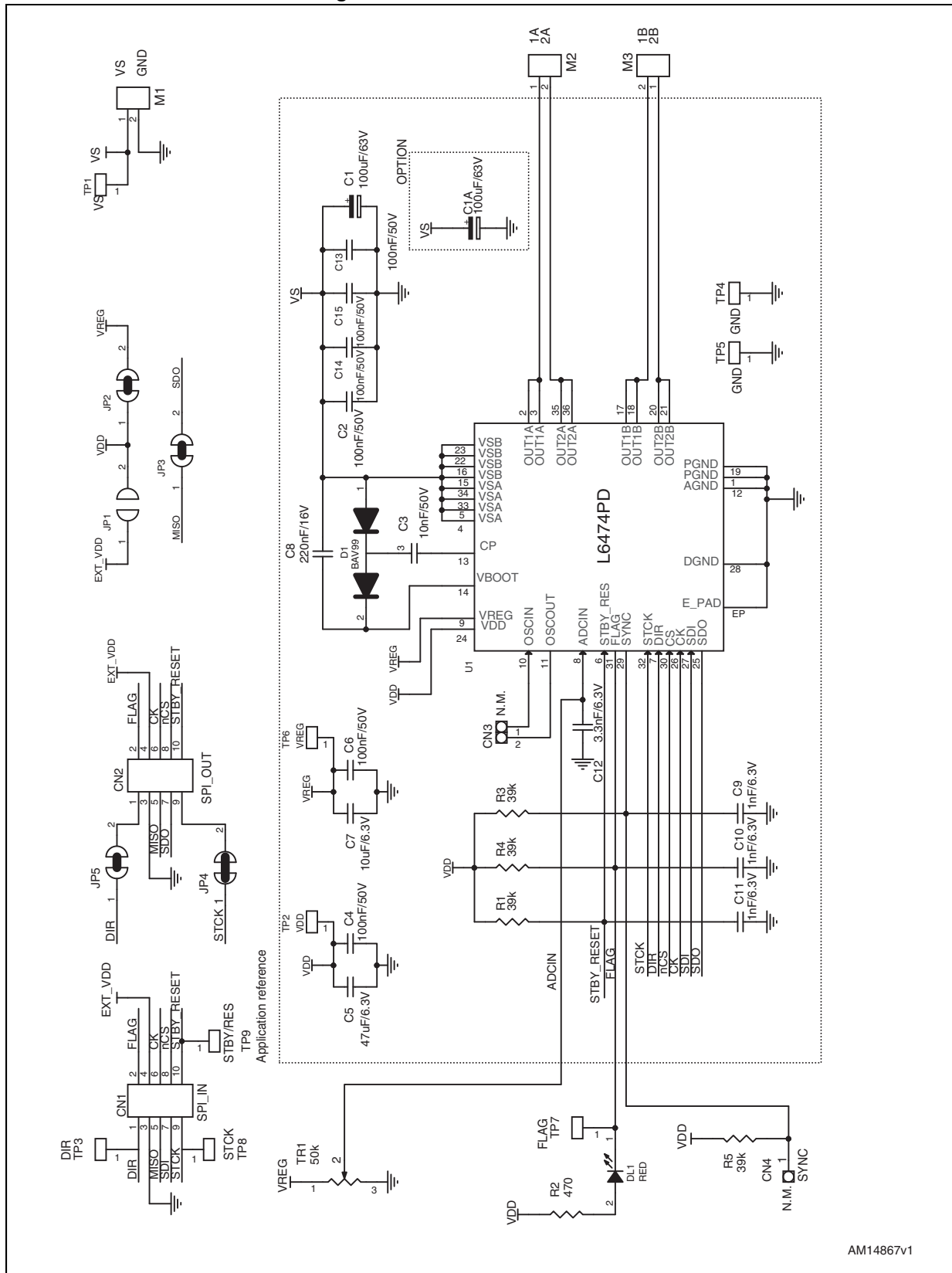
Table 3. Master SPI connector pinout (CN1)

Pin number	Type	Description
1	Open drain output	L6474 direction input
2	Open drain output	L6474 FLAG output
3	Ground	Ground
4	Supply	EXT_VDD (can be used as external logic power supply)
5	Digital output	SPI "Master In Slave Out" signal (connected to L6474 SDO output through daisy chain termination jumper JP2)
6	Digital input	SPI serial clock signal (connected to L6474 CK input)
7	Digital input	SPI "Master Out Slave In" signal (connected to L6474 SDI input)
8	Digital input	SPI slave select signal (connected to L6474 CS input)
9	Digital input	L6474 step-clock input
10	Digital input	L6474 standby/reset input

Table 4. Slave SPI connector pinout (CN2)

Pin number	Type	Description
1	Open drain output	L6474 direction input
2	Open drain output	L6474 FLAG output
3	Ground	Ground
4	Supply	EXT_VDD (can be used as external logic power supply)
5	Digital output	SPI "Master In Slave Out" signal (connected to pin 5 of J10)
6	Digital input	SPI serial clock signal (connected to L6474 CK input)
7	Digital input	SPI "Master Out Slave In" signal (connected to L6474 SDO output)
8	Digital input	SPI slave select signal (connected to L6474 CS input)
9	Digital input	L6474 step-clock input
10	Digital input	L6474 standby/reset input

Figure 2. EVAL6474PD schematic



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Table 5. Bill of material

Index	Quantity	Reference	Value	Package
1	1	C1	220 nF/16 V	CAPC-0603
2	1	C2	47 μ F/6.3 V	CAPC-3216
3	1	C3	100 nF/6.3 V	CAPC-0603
4	1	C4	10 μ F/4 V	CAPC-3216
5	1	C5	100 nF/4 V	CAPC-0603
6	4	C6, C7, C8, C10	100 nF/50 V	CAPC-0603
7	1	CN1	10-pole polarized IDC male header 2.54 mm vertical black	CON-FLAT-5 x 2 - 180 M
8	1	CN2	10-pole polarized IDC male header 2.54 mm vertical gray	CON-FLAT-5 x 2 - 180 M
9	1	CN3	N. M.	STRIP254P-M-2
10	1	CN4	N. M.	TPTH-RING-1MM
11	1	C1A	100 μ F/63 V	CAPE-R10HXX-P5
12	1	C1	100 μ F/63 V	CAPE-R10HXX
13	6	C2, C4, C6, C13, C14, C15	100 nF/50 V	CAPC-0603
14	1	C3	10 nF/50 V	CAPC-0603
15	1	C5	47 μ F/6.3 V	CAPC-1206
16	1	C7	10 μ F/6.3 V	CAPC-0805
17	1	C8	220 nF/16 V	CAPC-0603
18	3	C9, C10, C11	1 nF/6.3 V	CAPC-0603
19	1	C12	3.3 nF/6.3 V	CAPC-0603
20	1	DL1	LED red	LEDC-0805
21	1	D1	BAV99	SOT-23
22	1	JP1	Jumper open	JP2SO
23	4	JP2, JP3, JP4, JP5	Jumper closed	JP2SO
24	3	M1, M2, M3	Screw connector 2 poles	MORSV-508-2P

Figure 3. EVAL6474PD - layout (top layer)

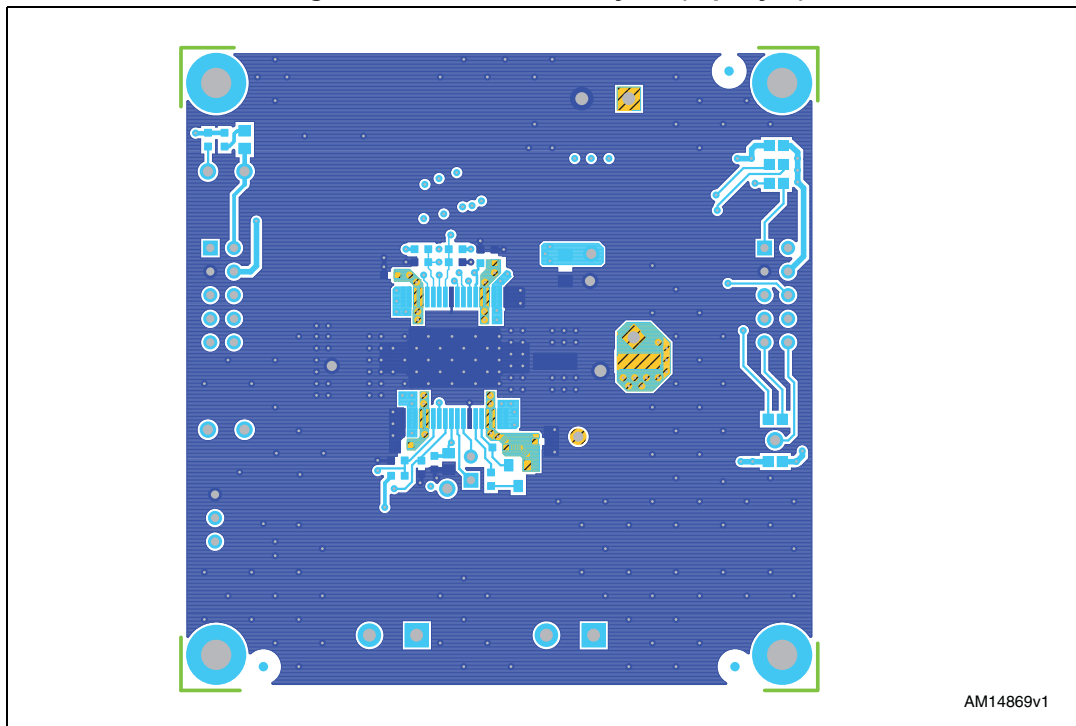


Figure 4. EVAL6474PD - layout (inner layer2)

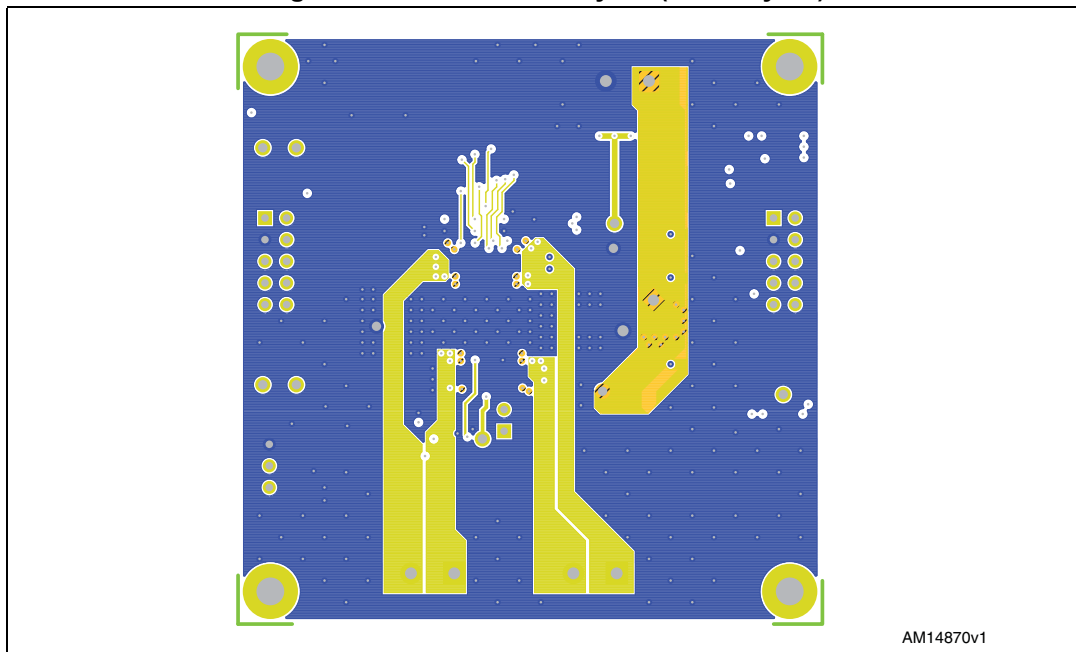


Figure 5. EVAL6474PD - layout (inner layer3)

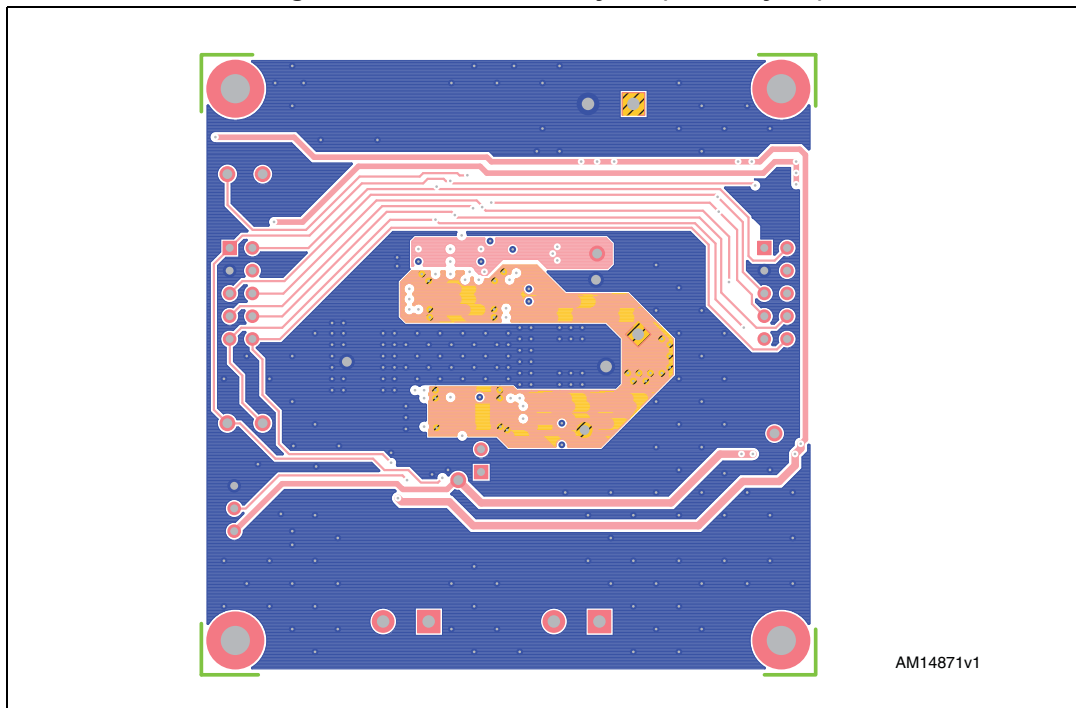
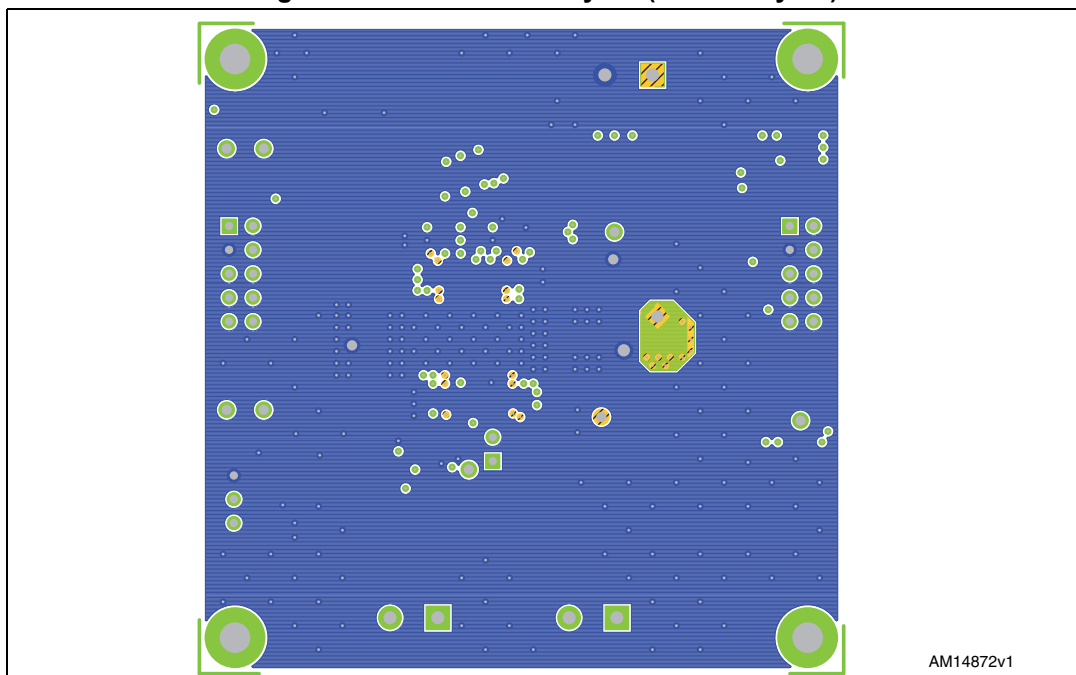
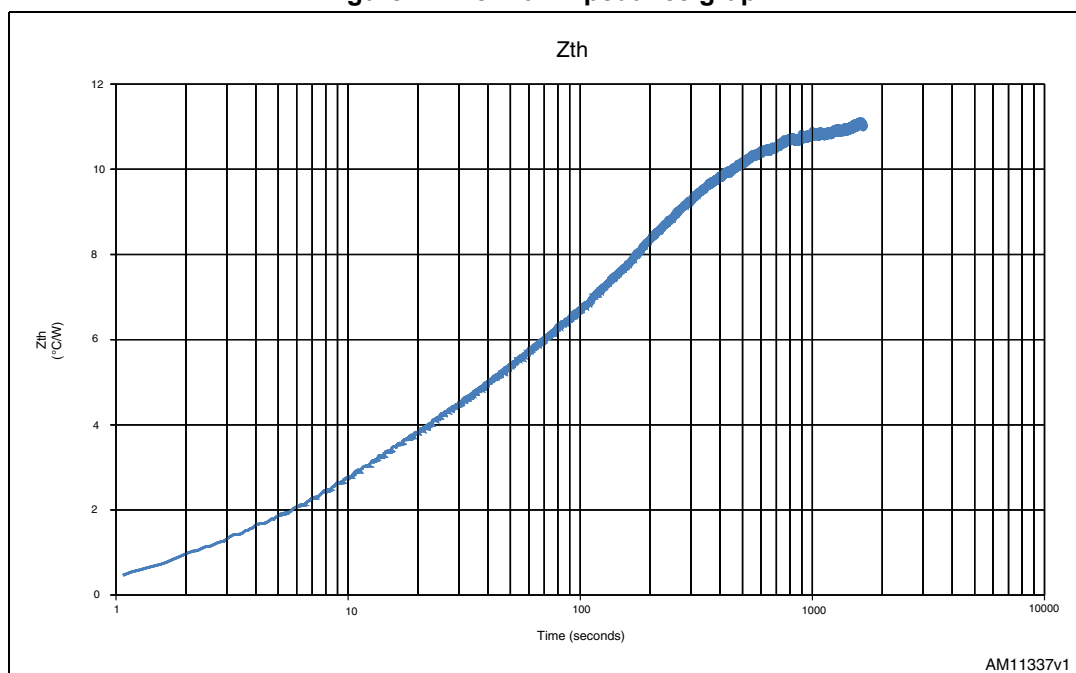


Figure 6. EVAL6474PD - layout (bottom layer3)



Thermal data

Figure 7. Thermal impedance graph



1 Revision history

Table 6. Document revision history

Date	Revision	Changes
07-Aug-2012	1	Initial release.
07-Sep-2012	2	In cover page, dSPIN has been changed into easySPIN.
19-Mar-2015	3	Replaced easySPIN by SPIN in Section : Description on page 1 . Removed Figure 3. EVAL6474PD - silkscreen from page 7. Updated Figure 7: Thermal impedance graph on page 9 (replaced by new figure). Minor modifications throughout document.

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